

Device Modeling Report

COMPONENTS: MOSFET (Professional)
PART NUMBER: 2SK2992
MANUFACTURER: TOSHIBA
Body Diode (Professional) / ESD Protection Diode



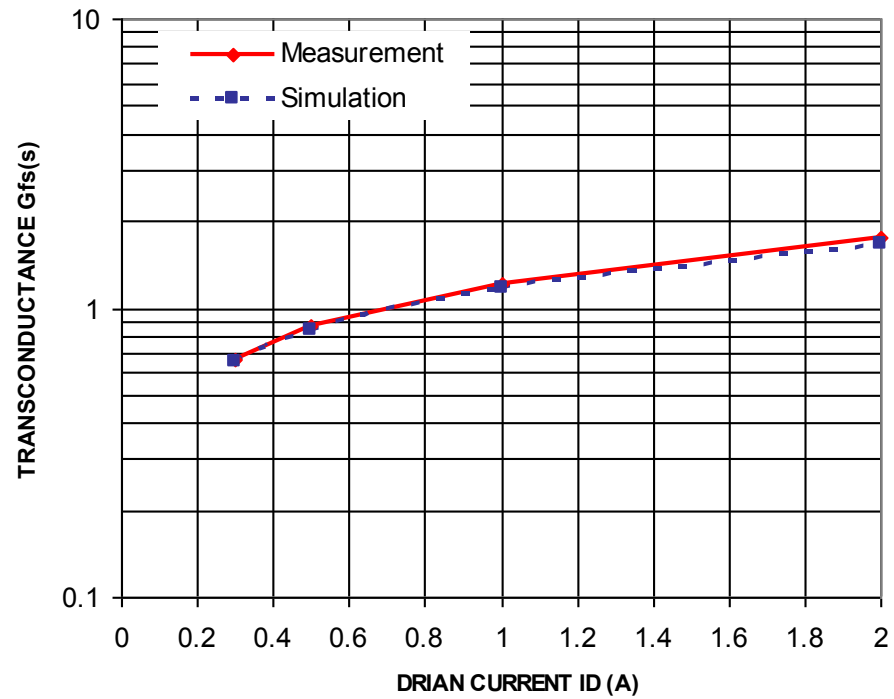
Bee Technologies Inc.

MOSFET MODEL PARAMETERS

PSpice model parameters	Model description
LEVEL	
L	Channel Length
W	Channel Width
KP	Transconductance
RS	Source Ohmic Resistance
RD	Ohmic Drain Resistance
VTO	Zero-bias Threshold Voltage
RDS	Drain-Source Shunt Resistance
TOX	Gate Oxide Thickness
CGSO	Zero-bias Gate-Source Capacitance
CGDO	Zero-bias Gate-Drain Capacitance
CBD	Zero-bias Bulk-Drain Junction Capacitance
MJ	Bulk Junction Grading Coefficient
PB	Bulk Junction Potential
FC	Bulk Junction Forward-bias Capacitance Coefficient
RG	Gate Ohmic Resistance
IS	Bulk Junction Saturation Current
N	Bulk Junction Emission Coefficient
RB	Bulk Series Resistance
PHI	Surface Inversion Potential
GAMMA	Body-effect Parameter
DELTA	Width effect on Threshold Voltage
ETA	Static Feedback on Threshold Voltage
THETA	Mobility Modulation
KAPPA	Saturation Field Factor
VMAX	Maximum Drift Velocity of Carriers
XJ	Metallurgical Junction Depth
UO	Surface Mobility

Transconductance Characteristic

Circuit Simulation Result

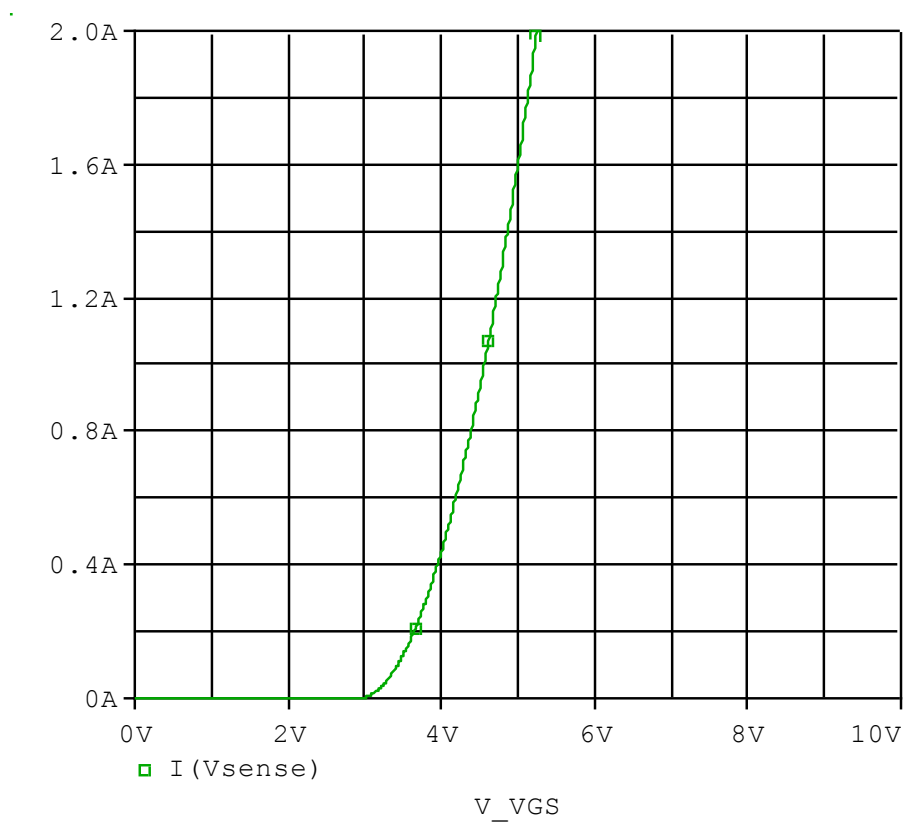


Comparison table

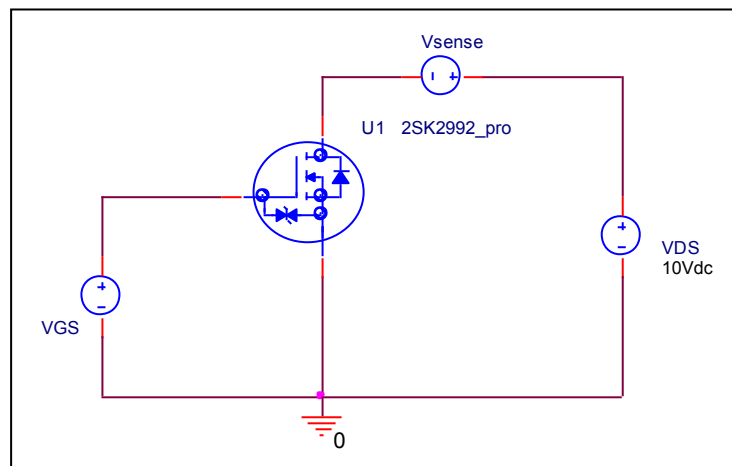
Id(A)	Gfs(S)		Error(%)
	Measurement	Simulation	
0.1	0.09704	0.09804	1.03051
0.2	0.22927	0.22727	-0.87232
0.4	0.34854	0.35054	0.57382
1.2	0.56366	0.55787	-1.02722
1.6	0.70985	0.70765	-0.30992
2	1.03093	1.04033	0.91180

Vgs-Id Characteristic

Circuit Simulation result

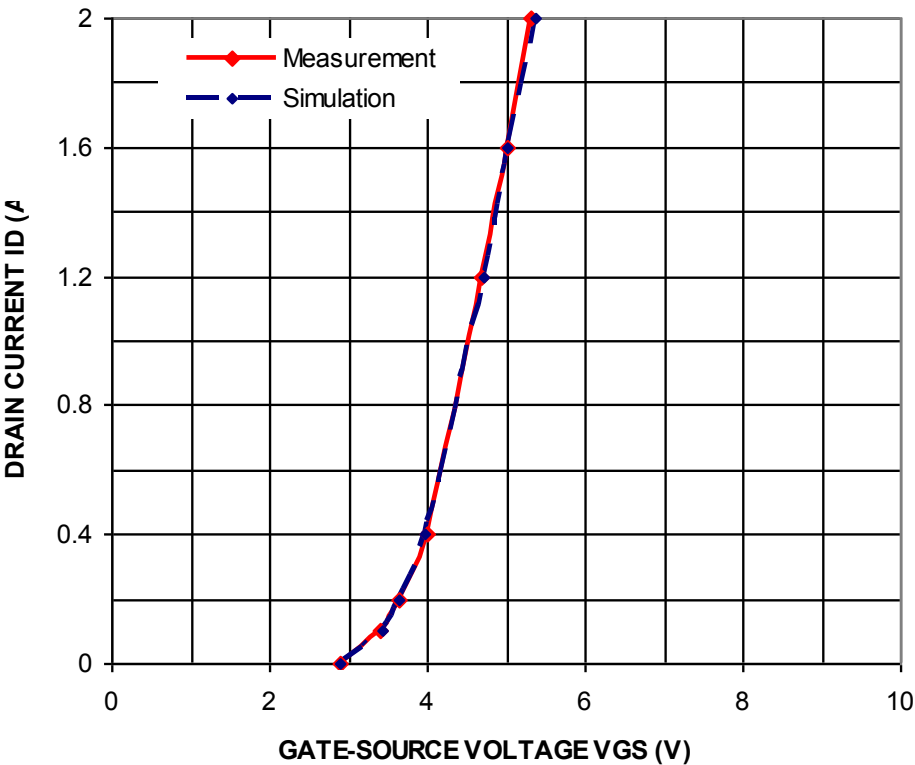


Evaluation circuit



Comparison Graph

Circuit Simulation Result

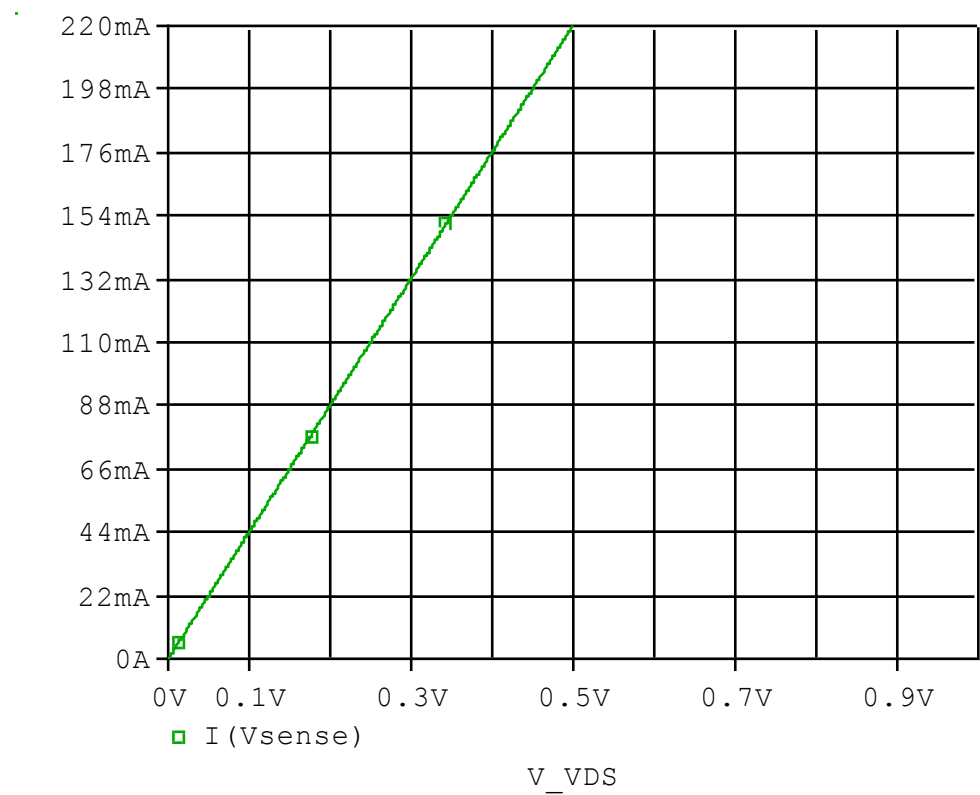


Simulation Result

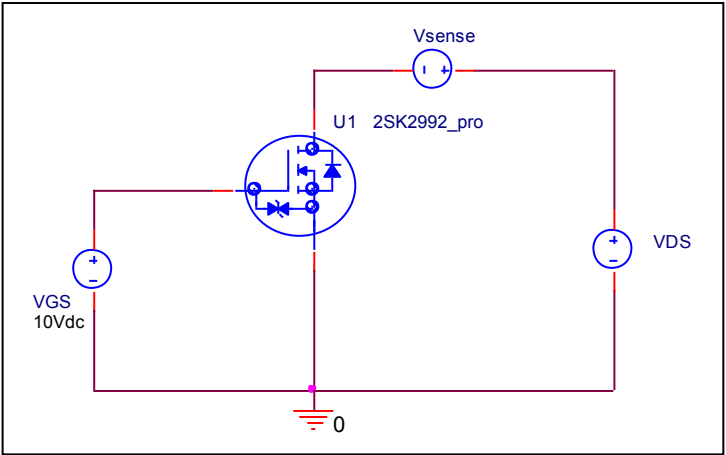
I _D (A)	V _{GS} (V)		Error (%)
	Measurement	Simulation	
0.1	3.4000	3.4298	0.8765
0.2	3.6500	3.6456	-0.1205
0.4	4.0000	3.9700	-0.7500
1.2	4.7000	4.7187	0.3979
1.6	5.0000	5.0006	0.0120
2	5.3000	5.3807	1.5217

Rds(on) Characteristic

Circuit Simulation result



Evaluation circuit

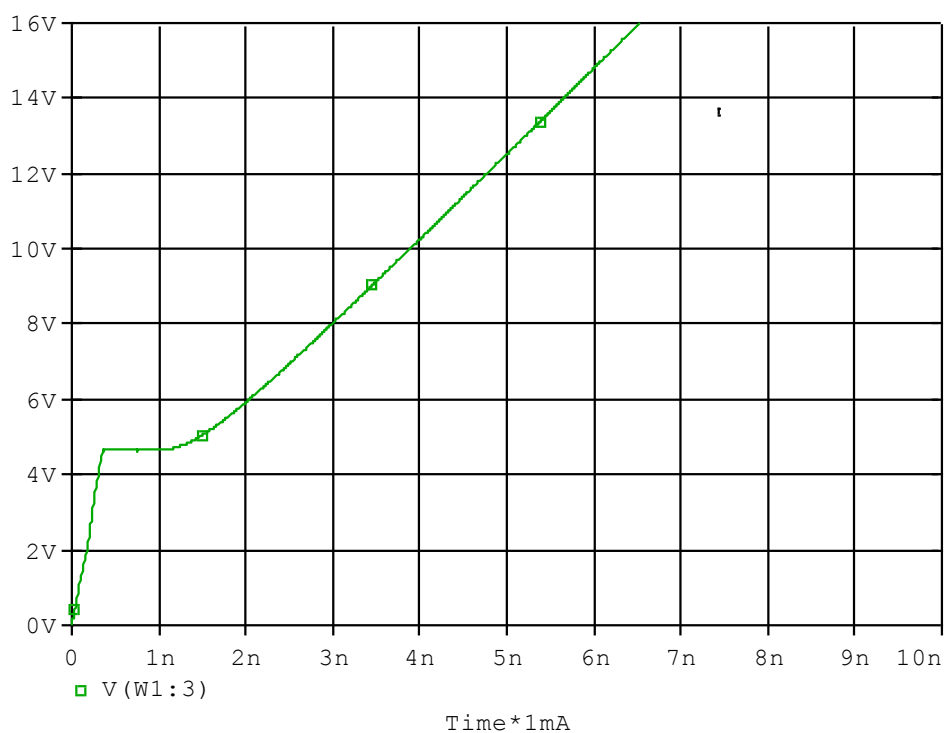


Simulation Result

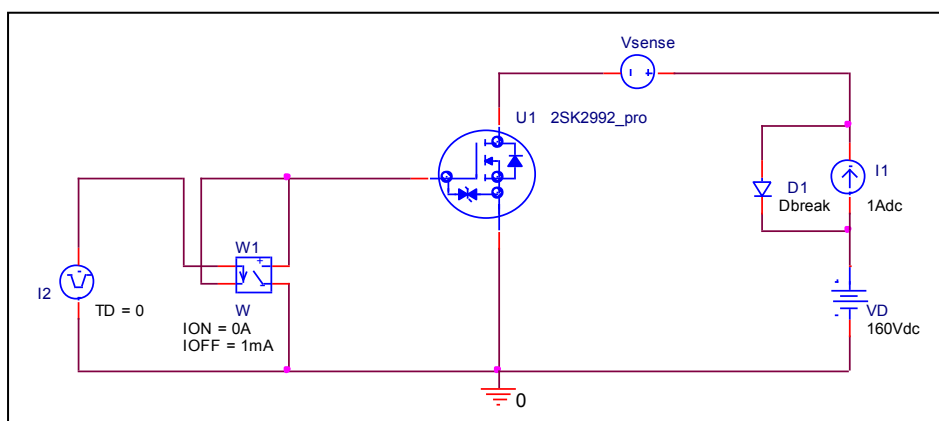
$I_D=0.5A, V_{GS}=10V$	Measurement		Simulation		Error (%)
$R_{DS} \text{ (on)}$	2.2	Ω	2.2	Ω	0.000

Gate Charge Characteristic

Circuit Simulation result

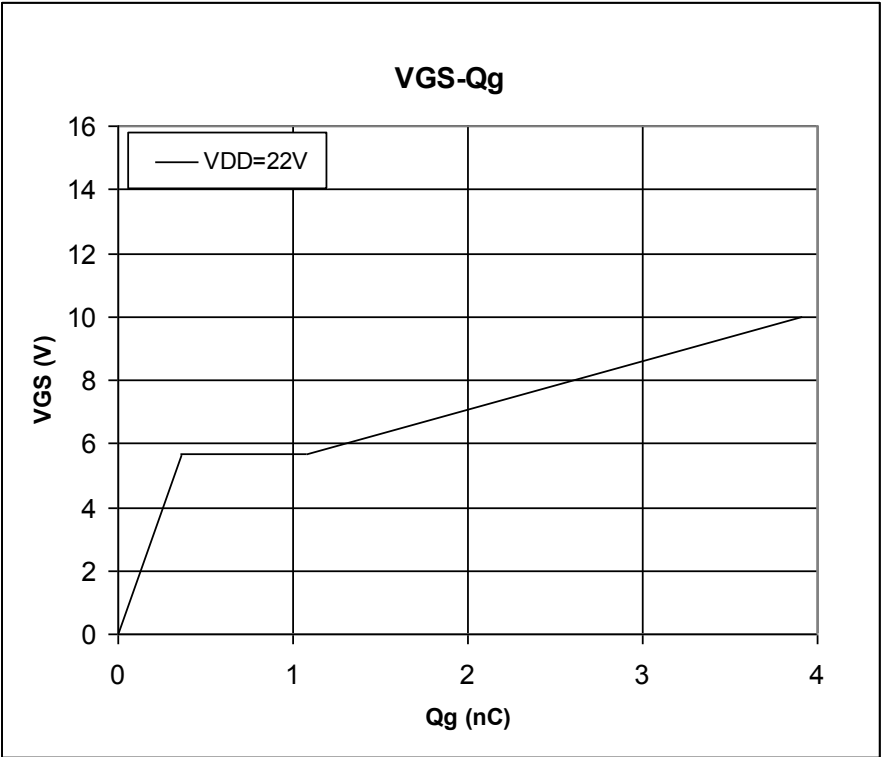


Evaluation circuit

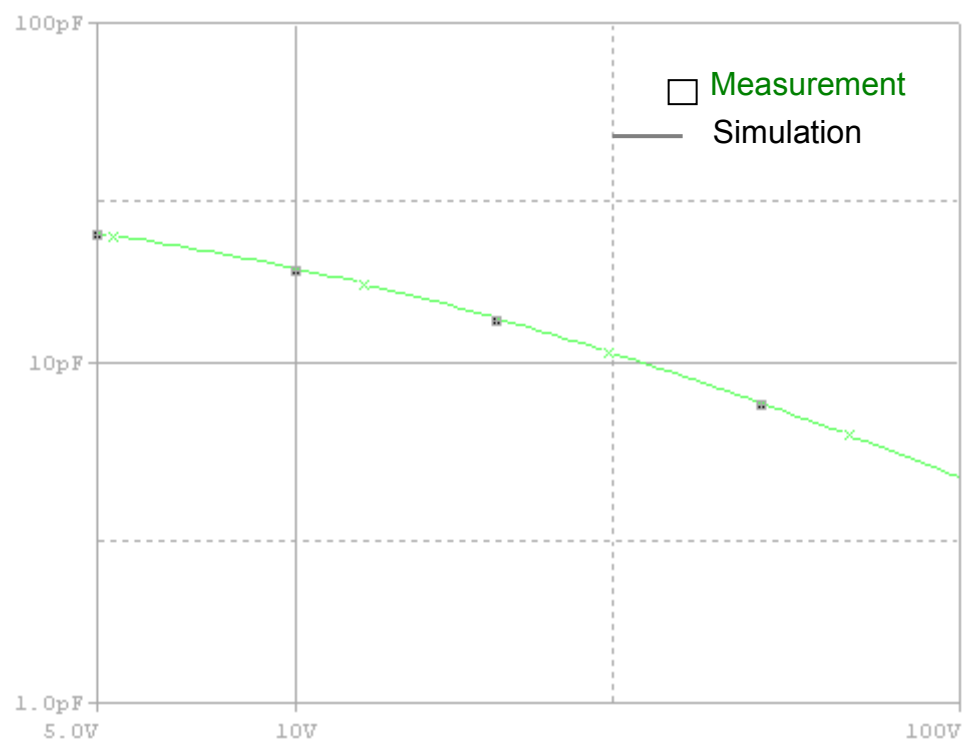


Simulation Result

$V_{DD}=160V$, $I_D=1A$	Measurement		Simulation		Error (%)
Qgs	0.3600	nC	0.3590	nC	-0.2778
Qgd	1.0800	nC	1.0850	nC	0.4630
Qg	3.920	nC	3.9000	nC	0.5100



Capacitance Characteristic

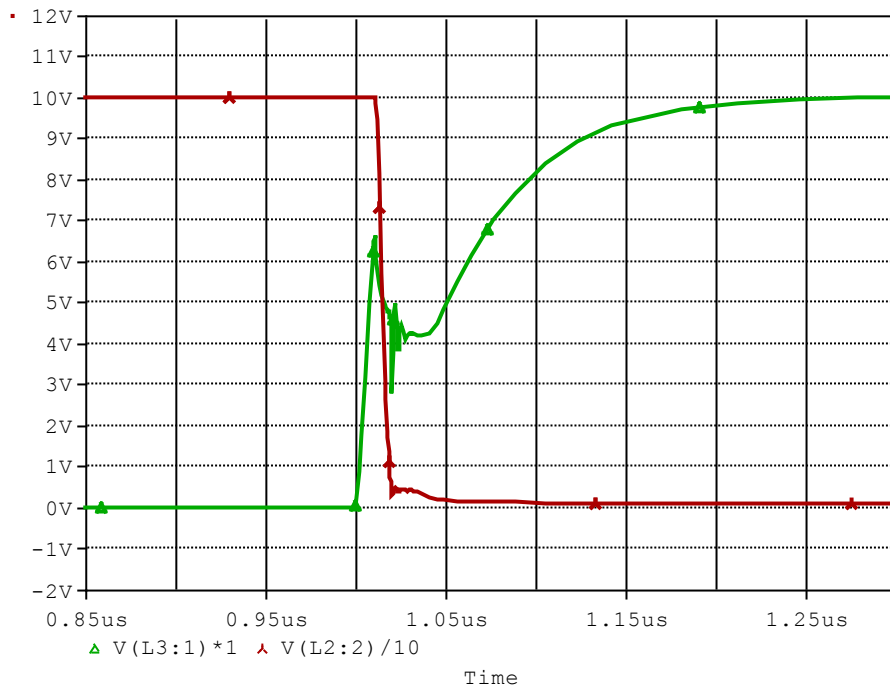


Simulation Result

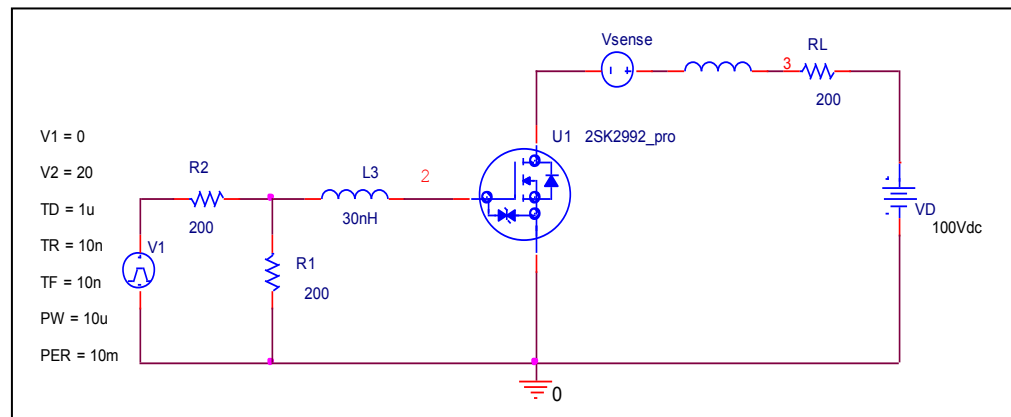
V _{DS} (V)	Cbd(pF)		Error(%)
	Measurement	Simulation	
5	24.000	24.119	0.496
10	19.000	18.911	-0.468
20	13.500	13.514	0.104
50	7.600	7.615	0.197

Switching Time Characteristic

Circuit Simulation result



Evaluation circuit

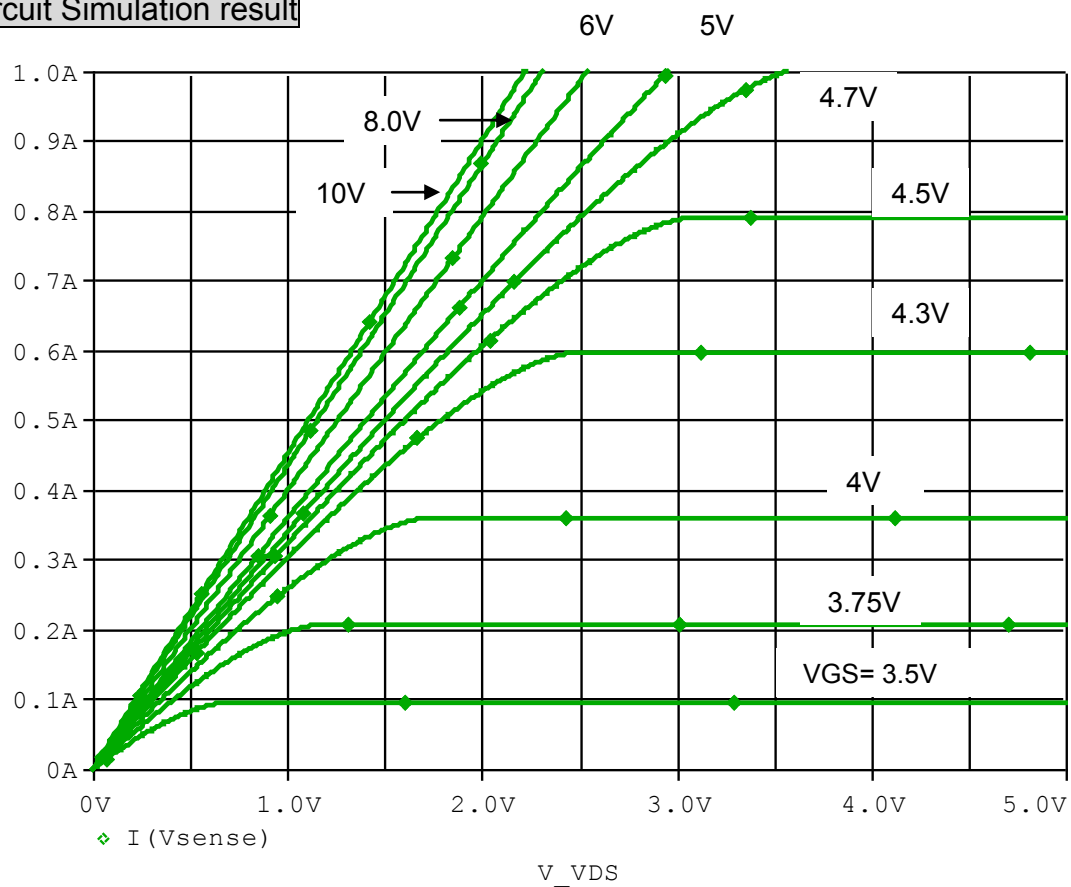


Simulation Result

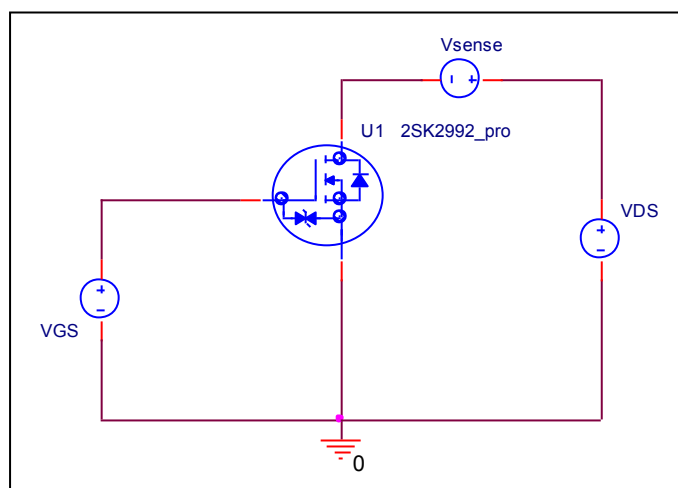
$I_D=0.5A$, $V_{DD}=100V$, $V_{GS}=0/10V$	Measurement		Simulation		Error(%)
Td(on)	17.000	ns	17.012	ns	0.0706

Output Characteristic

Circuit Simulation result



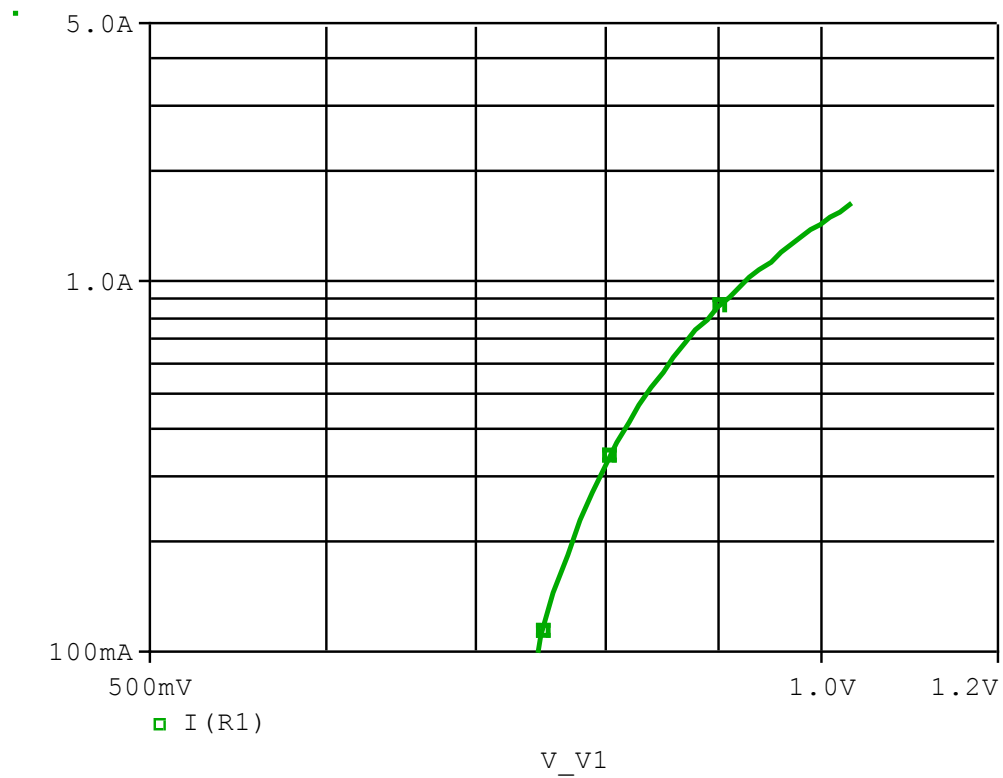
Evaluation circuit



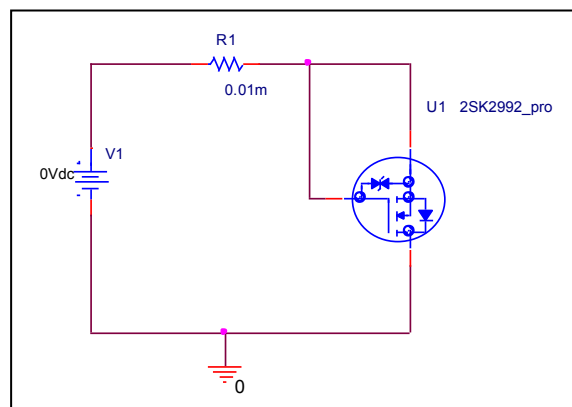
BODY DIODE SPICE MODEL

Forward Current Characteristic

Circuit Simulation Result

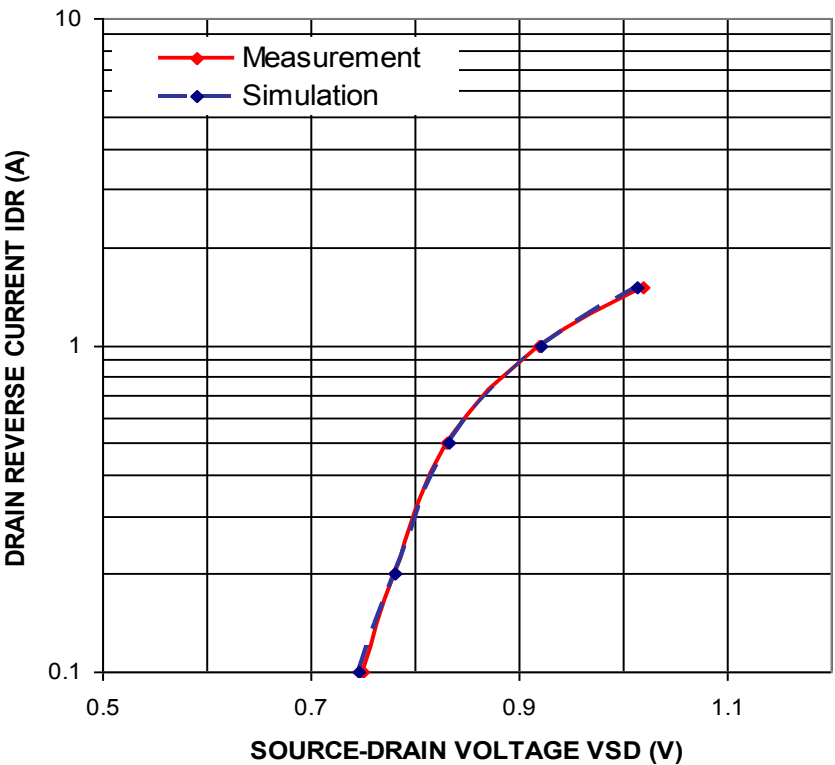


Evaluation Circuit



Comparison Graph

Circuit Simulation Result

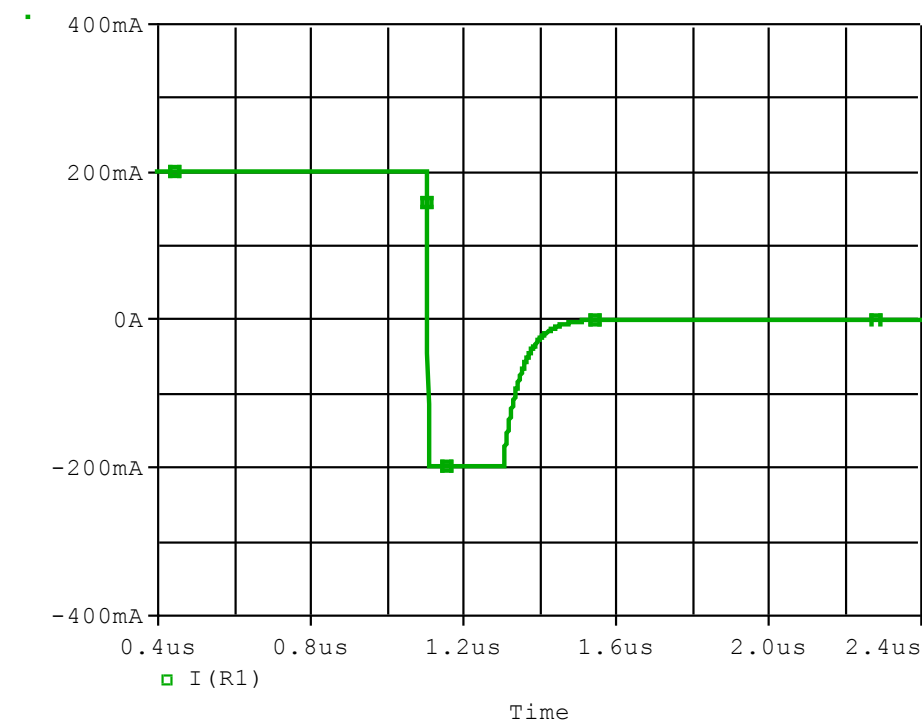


Simulation Result

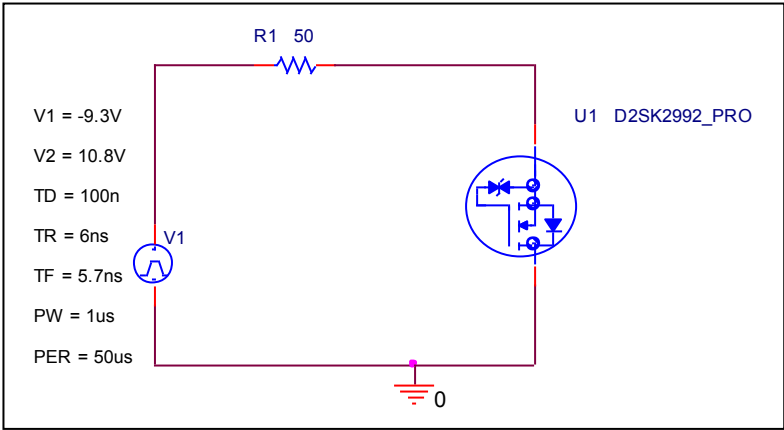
IDR(A)	VSD(V)		%Error
	Measurement	Simulation	
0.1	0.7500	0.7469	-0.4133
0.2	0.7800	0.7800	0.0000
0.5	0.8300	0.8320	0.2410
1	0.9200	0.9210	0.1087
1.5	1.0200	1.0132	-0.6667

Reverse Recovery Characteristic (Body Diode)

Circuit Simulation Result



Evaluation Circuit

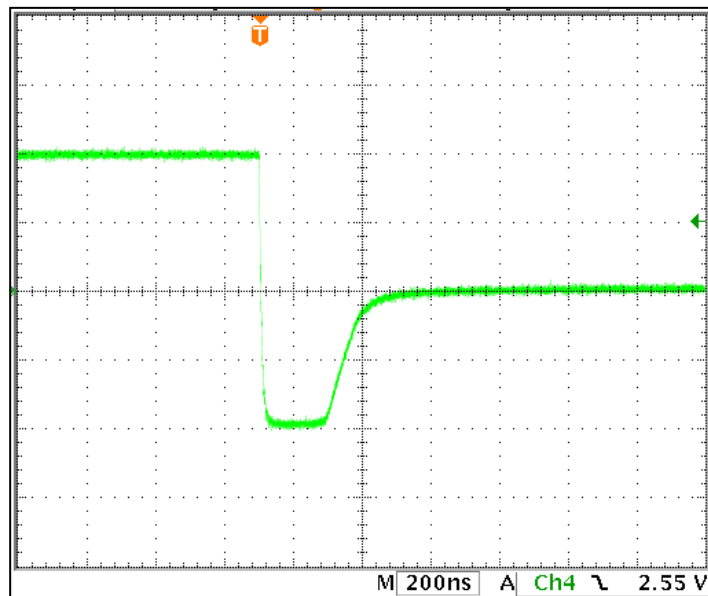


Compare Measurement vs. Simulation

	Measurement		Simulation		Error (%)
trj	196.000	ns	196.120	ns	0.061
trb	108.000	ns	108.500	ns	0.463
trr	304.000	ns	305.200	ns	0.395

Reverse Recovery Characteristic (Body Diode)

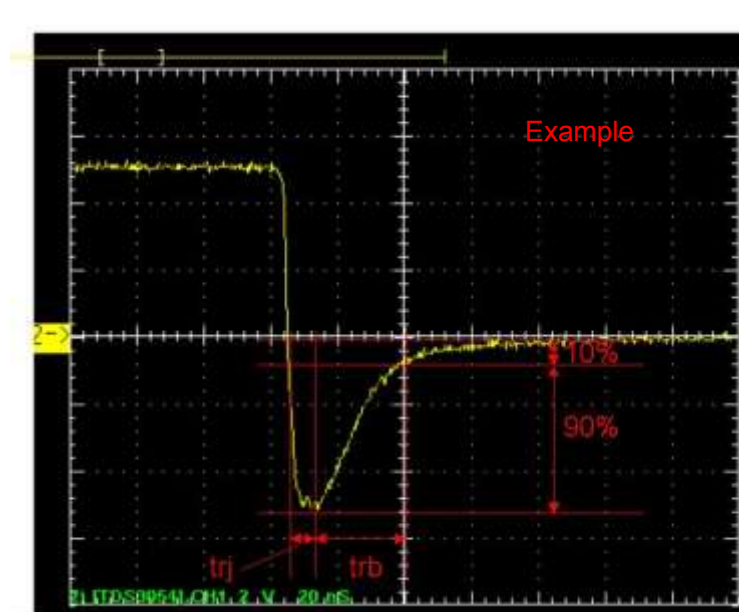
Reference



$T_{rj} = (196\text{ns})$

$T_{rb} = (108\text{ns})$

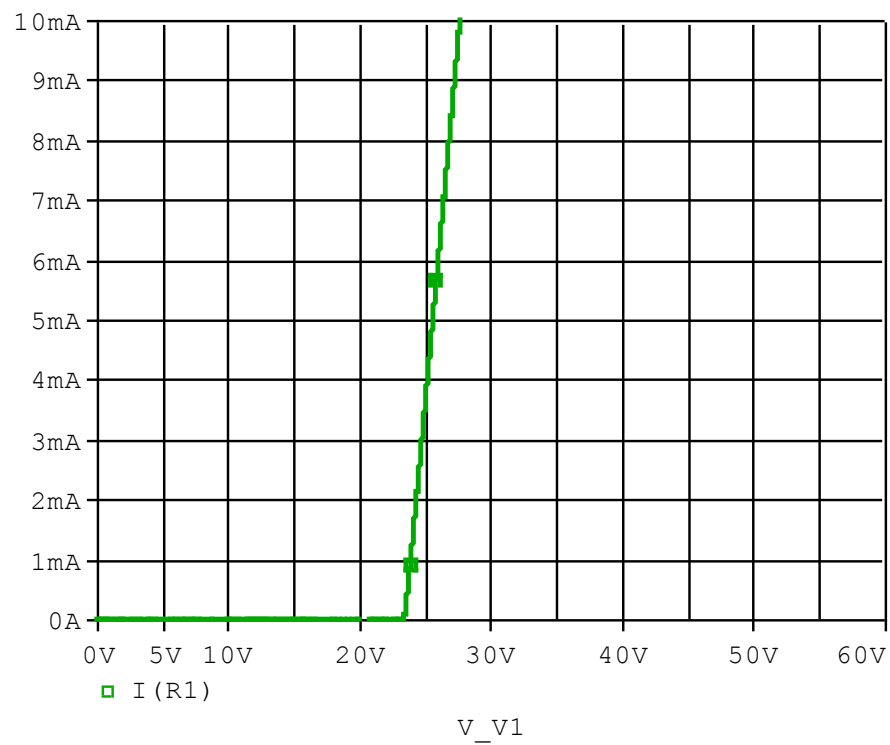
Conditions: $I_{fwd} = 0.2$, $I_{rev} = 0.2(\text{A})$, $R_I = 50$



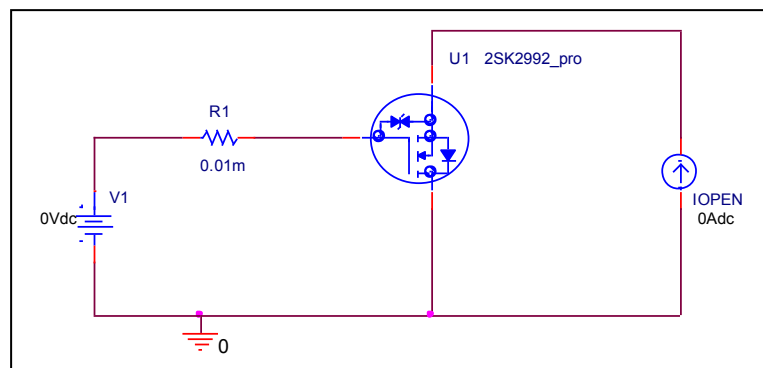
Relation between t_{rj} and t_{rb}

Zener Voltage Characteristic

Circuit Simulation Result



Evaluation Circuit



Zener Voltage Characteristic

Reference

